

MICROWAVE CORPORATION V03.1105

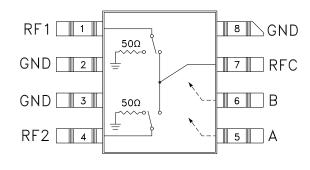


Typical Applications

The HMC232C8 is ideal for:

- Telecom Infrastructure
- Microwave Radio & VSAT
- Military Radios, Radar & ECM
- Test Instrumentation

Functional Diagram



GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Features

Isolation: 55 dB @ 2 GHz 43 dB @ 6 GHz Insertion Loss: 1.6 dB Typical @ 6 GHz Non-Reflective Design Surface Mount Ceramic Package Direct Replacement for HMC132C8

General Description

The HMC232C8 is a broadband high isolation nonreflective GaAs MESFET SPDT switch in a nonhermetic surface mount ceramic package. Covering DC to 8 GHz, the switch features >55 dB isolation up to 2 GHz and >42 dB isolation up to 8 GHz. The switch operates using complementary negative control voltage logic lines of -5/0V and requires no bias supply. This product is a form, fit & functional replacement for the HMC132C8.

Electrical Specifications, $T_A = +25^{\circ}$ C, With 0/-5V Control, 50 Ohm System

Parameter	Frequency	Min.	Тур.	Max.	Units
Insertion Loss	DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz		1.2 1.6 2.2	1.5 2.0 2.8	dB dB dB
Isolation	DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz	50 38 37	55 43 42		dB dB dB
Return Loss "On State"	DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz		19 12 10		dB dB dB
Return Loss RF1, RF2 "Off State"	DC - 2.0 GHz DC - 6.0 GHz DC - 8.0 GHz		13 8 7		dB dB dB
Input Power for 1 dB Compression	0.5 - 8.0 GHz	22	26		dBm
Input Third Order Intercept (Two-Tone Input Power= +7 dBm Each Tone, 1 MHz Tone Separation)	0.5 - 8.0 GHz	40	46		dBm
Switching Characteristics tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)	DC - 8.0 GHz		3 5		ns ns

For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

SWITCHES - SMT

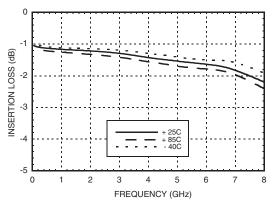


MICROWAVE CORPORATION V03.1105

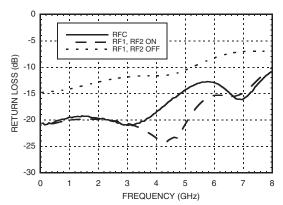


GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Insertion Loss

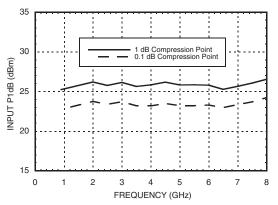


Return Loss

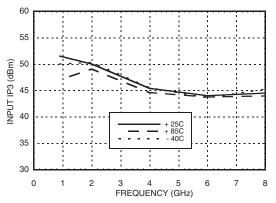


Isolation -10 RF1 -20 - RF2 **ISOLATION (dB)** -30 -40 -50 -60 -70 0 1 2 3 4 5 6 7 8 FREQUENCY (GHz)

0.1 and 1 dB Input Compression Point







For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

10

SWITCHES - SMT



MICROWAVE CORPORATION V03.1105



GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Absolute Maximum Ratings

RF Input Power (Vctl= -5V) (0.5 - 8 GHz)	+30 dBm (@ +50 °C)
Control Voltage Range (A & B)	+1.0V to -7.5 Vdc
Channel Temperature	150 °C
Thermal Resistance	94 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A

ELECTROSTATIC SENSITIVE DEVICE

OBSERVE HANDLING PRECAUTIONS



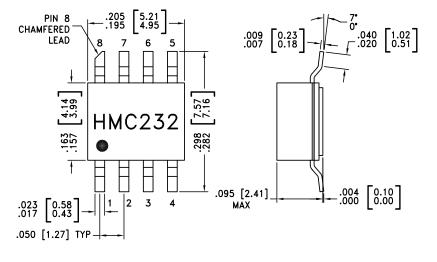
State	Bias Condition
Low	0 to -0.2V @ 10 uA Max.
High	-5V @ 10 uA Typ. to -7V @ 45 uA Typ.

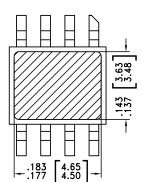
Truth Table

Control Input		Signal Path State		
A	В	RFC to RF1	RFC to RF2	
High	Low	ON	OFF	
Low	High	OFF	ON	

Caution: Do not "Hot Switch" power levels greater than +26 dBm (Vctl = 0/-5 Vdc).

Outline Drawing





NOTES:

- 1. PACKAGE BODY MATERIAL: WHITE ALUMINA 92%
- 2. LEAD, PACKAGE BOTTOM MATERIAL: COPPER
- 3. PLATING: ELECTROLYTIC GOLD 100-200 MICROINCHES, OVER
 - ELECTROLYTIC NICKEL 100-250 MICROINCHES.
- 4. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 5. PACKAGE LENGTH AND WIDTH DIMENSIONS DO NOT INCLUDE LID SEAL PROTRUSION .005 PER SIDE.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com

10

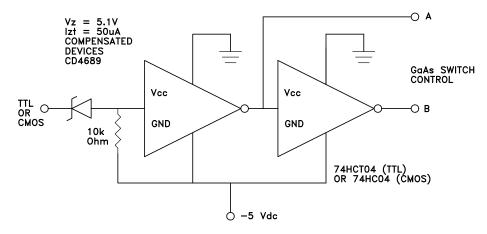


MICROWAVE CORPORATION V03.1105



GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Suggested Driver Circuit



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 4, 7	RF1, RF2, RFC	This pin is DC coupled and matched to 50 Ohm. Blocking capacitors are required if RF line potential is not equal to 0V.	
2, 3, 8	GND	Package bottom must also be connected to PCB RF ground.	
5	А	See truth table and control voltage table.	R
6	В	See truth table and control voltage table.	⊥_ c ⊥_

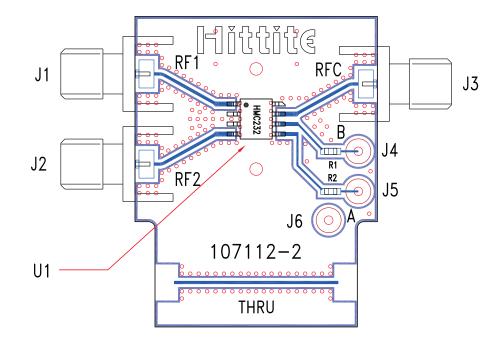


MICROWAVE CORPORATION V03.1105



GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Evaluation PCB



List of Materials for Evaluation PBC 107261 ^[1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4 - J6	DC Pin
R1, R2	100 Ohm Resistor, 0603 Pkg.
U1	HMC232C8 SPDT Switch
PCB [2]	107112 Evaluation PCB

Reference this number when ordering complete evaluation PCB
Circuit Board Material: Rogers 4350

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines at the RF port should have 50 ohm impedance and the package ground leads and package bottom should be connected directly to the ground plane similar to that shown above. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.



MICROWAVE CORPORATION V03.1105



GaAs MMIC SMT HIGH ISOLATION SPDT SWITCH, DC - 8 GHz

Notes:

For price, delivery, and to place orders, please contact Hittite Microwave Corporation: 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com